

# ANTREX Electronics

Electronic Components Sourcing Information

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## Product Reference Information

**Part Number:** AMC60804YBHT  
**Manufacturer:** Texas Instruments  
**Package:** 36-XFBGA, DSBGA  
**Availability:** Please confirm with sales

**Product Page:**

<https://antrexco.com/product/details/texas-instruments/amc60804ybht.html>

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## Contact Information

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## Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

**Note:**

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

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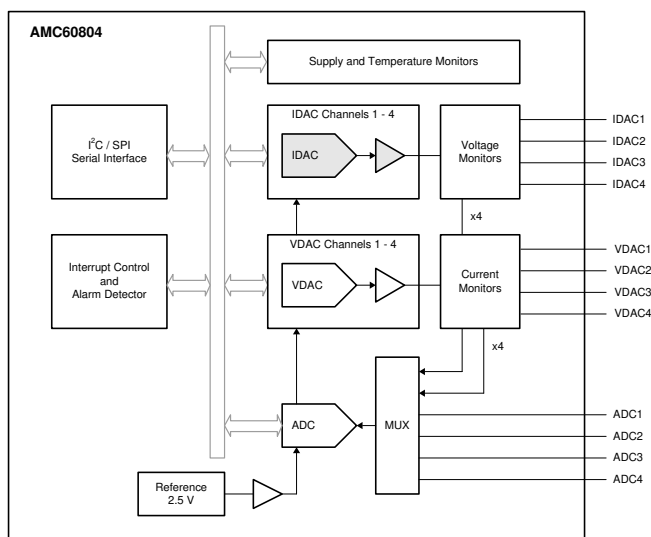
# AMC60804 4-Channel, EML Monitor and Controller With Current and Voltage Output DACs and Multichannel ADC

## 1 Features

- Four 12-bit current output DACs (IDACs)
  - 150-mA full-scale output range
- Four 12-bit voltage output DACs (VDACs)
  - Selectable full-scale output ranges: –5 V, –2.5 V, +2.5 V and +5 V
  - High-current drive capability:  $\pm 50$  mA
- Twelve channel, 12-bit, 1-MSPS SAR ADC
  - Four external inputs: 2.5-V and 5-V input ranges
  - Four IDAC voltage monitor channels
  - Four VDAC current monitor channels
  - Programmable sequencer
  - Programmable out-of-range alarms
- Internal 2.5-V reference
- Supply and temperature fault alarms
- SPI and I<sup>2</sup>C interfaces: 1.7-V to 3.6-V operation
  - SPI: 4-wire interface
  - I<sup>2</sup>C: Four slave addresses
- Specified temperature range: –40°C to +125°C

## 2 Applications

- [Optical module](#)
- [Intra-dc interconnect \(metro\)](#)



**Simplified Schematic**

## 3 Description

The AMC60804 is a highly integrated, low-power analog monitor and controller optimized for electro-absorption modulated lasers (EML).

The AMC60804 includes four 12-bit current output digital-to-analog converters (IDACs) and four 12-bit voltage output DACs (VDACs) with programmable output ranges. The AMC60804 also includes a 12-bit, 1-MSPS analog-to-digital converter (ADC) used for external signal and internal signal monitoring, supply and temperature alarm monitors, and a high-precision internal reference.

The AMC60804 VDACs support both positive and negative output range operation and are capable of sourcing and sinking up to 50 mA, making them an excellent choice for biasing the electro-absorption modulator (EAM) in an EML. Additionally, the AMC60804 IDACs support a full-scale output range of 150 mA with very low power dissipation, thus eliminating the need for external components to bias the EML laser diode. In combination the AMC60804 four VDACs and four IDACs enable accurate biasing of up to four EML lasers.

The AMC60804 includes four input pins that are multiplexed to the ADC and incorporate a low-latency window comparator, making this device an excellent choice for received signal strength indicator (RSSI) and loss-of-signal (LOS) detection. The ADC is also capable of measuring the voltage at the IDAC pins, as well as the current being sourced or sunk by the VDACs, thus enabling monitoring of these outputs.

The AMC60804 low power, high integration, very small size, and wide operating temperature range make the device an excellent choice as an all-in-one, low-cost control circuit for the EML lasers found in optical modules. Contact TI sales for the full data sheet.

### Device Information

| PART NUMBER | PACKAGE <sup>(1)</sup> | BODY SIZE (NOM)   |
|-------------|------------------------|-------------------|
| AMC60804    | DSBGA (36)             | 2.56 mm × 2.56 mm |

- (1) For all available packages, see the package option addendum at the end of the data sheet.



## 4 Device and Documentation Support

### 4.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 4.2 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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### 4.3 Trademarks

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### 4.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 4.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 5 Mechanical, Packaging, and Orderable Information

The following pages include packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">AMC60804YBHR</a> | Active        | Production           | DSBGA (YBH)   36 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 105   | AMC60804            |
| AMC60804YBHR.A               | Active        | Production           | DSBGA (YBH)   36 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 105   | AMC60804            |
| <a href="#">AMC60804YBHT</a> | Active        | Production           | DSBGA (YBH)   36 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 105   | AMC60804            |
| AMC60804YBHT.A               | Active        | Production           | DSBGA (YBH)   36 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 105   | AMC60804            |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

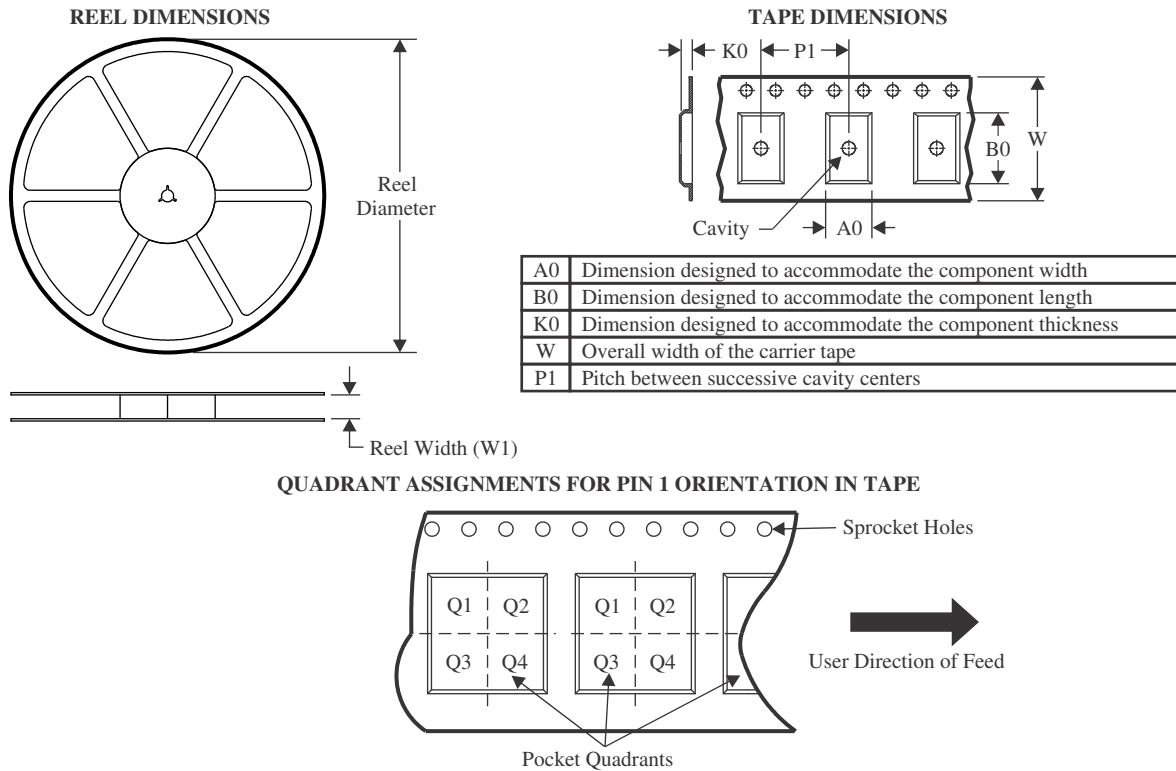
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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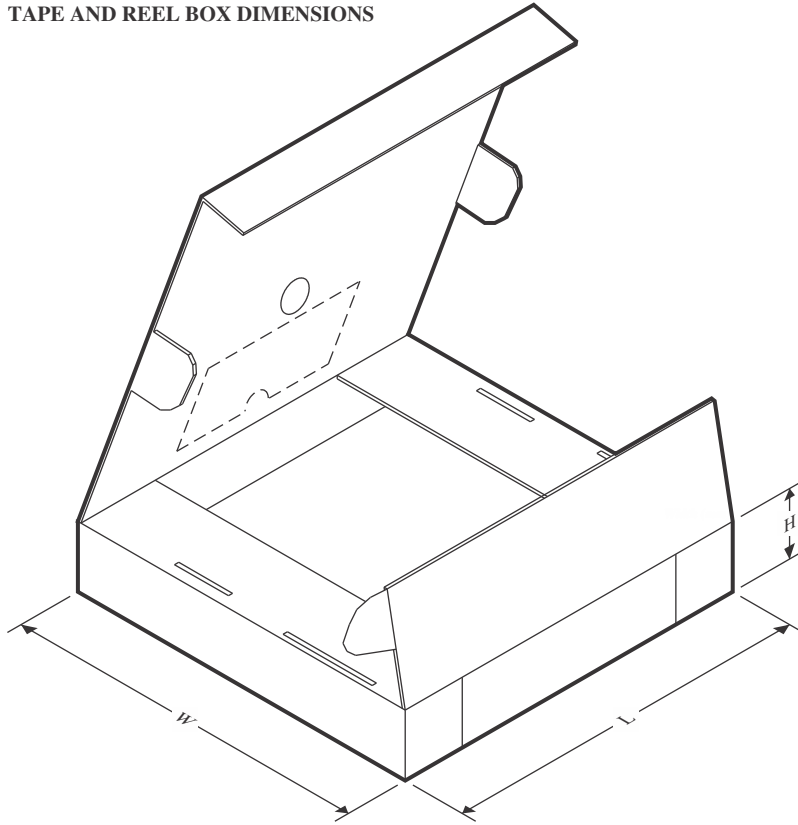
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| AMC60804YBHR | DSBGA        | YBH             | 36   | 3000 | 180.0              | 8.4                | 2.71    | 2.71    | 0.6     | 4.0     | 8.0    | Q1            |
| AMC60804YBHT | DSBGA        | YBH             | 36   | 250  | 180.0              | 8.4                | 2.71    | 2.71    | 0.6     | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| AMC60804YBHR | DSBGA        | YBH             | 36   | 3000 | 182.0       | 182.0      | 20.0        |
| AMC60804YBHT | DSBGA        | YBH             | 36   | 250  | 182.0       | 182.0      | 20.0        |

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